

CALL FOR PAPERS

Symposium Technical Chair

A. James (Jim) McLenaghan, Creyr Innovation, LLC

The Largest Regional Symposium Dedicated to Microelectronics and Packaging

Tuesday May 7th, 2013

---- Featuring -----

Six to Eight Lecture Sessions, Full Poster Session, Employment Center & 80 Booth Exhibit Hall



Holiday Inn Boxborough Woods Conference Center - Boxborough, Massachusetts

The New England Chapter Symposium Technical Program Committee seeks papers that demonstrate how new technologies and applications are expanding and redefining microelectronics. Areas of interests include:

Industry

- Medical Electronics
- Lasers
- Telecom RF & Microwave
- Military Electronics
- Consumer Electronics
- Renewable Energy: Fuel Cells, Solar, Wind
- Thermal & Power Management
- Manufacturing, Outsourcing & Quality
- Software and Firmware Applications
- High Performance Interconnects and Boards
- Sensors (Manufacturing & Applications)
- Emerging Technologies
- Solar, Photovoltaic
- Aerospace
- Electronics for Environmental Impact Measurement & Assessment

Advanced Processes & Materials

- 3D, SiP, and High Density Packaging
- Nano Materials Mfg., Applications, & Safety
- Photonics, Optoelectronics, LED Packaging
- MEMS and Nano Packaging
- Underfill Materials, Applications, Effectiveness
- Green packaging Regulation Compliance, Materials, Processes, Recycling
- Flip-Chip and Bumping Processes & Reliability
- Wire-bonding and Stud-Bumping
- Embedded Components Passives, Magnetics
- Ceramic, Polymer and Conductive Materials
- Cu. Low-K
- Product DFR & DFM Tools, Programs, Implementation
- Materials Deposition & Delivery Print, Vapor, Dispensing, Placement, etc.

Please send 250 word abstract to: Jim McLenaghan, AJM@Creyr.NET

for more details visit us at: www.imapsne.org

Deadline for Abstract Submission - Monday December 31, 2012

For details about Sponsoring, Exhibiting or Attending

Contact Harvey Smith: harveys@imapsne.org or Call 508-699-4767

Please submit abstracts to:	Jim McLenaghan Email: ajm@creyr.net Phone: 401-885-5444
	Please put information in this column
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